

N-Channel Enhancement Mode MOSFET

General Description

This N-Channel MOSFET is produced using Cmos's advanced Power Trench process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Features

- N-Channel MOSFET
- Low ON-resistance
- Surface Mount Package
- RoHS Compliant

Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	40	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D@T_C=25^\circ C$	Continuous Drain Current	22	A
$I_D@T_C=100^\circ C$		13	A
I_{DM}	Pulsed Drain Current	44	A
EAS	Single Pulse Avalanche Energy ¹	67	mJ
$P_D@T_C=25^\circ C$	Total Power Dissipation	30	W
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ C$
T_J	Operating Junction Temperature Range	-55 to 150	$^\circ C$

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	---	53	$^\circ C/W$

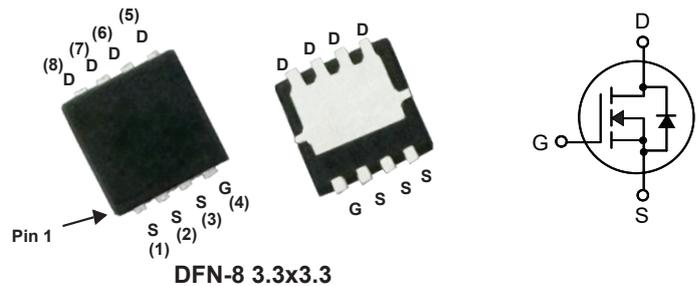
Product Summary

BVDSS	RDSON	ID
40V	21m Ω	22A

Applications

- High side in DC - DC Buck Converters
- Notebook battery power management
- Load switch in Notebook

DFN-8 3.3x3.3 Pin Configuration



Type	Package	Marking
CMSC8015	DFN-8 3.3*3.3	8015

Electrical Characteristics ($T_J=25^{\circ}\text{C}$, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	40	---	---	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=10V, I_D=12A$	---	16.5	21	m Ω
		$V_{GS}=4.5V, I_D=10A$	---	22	30	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}, I_D=250\mu A$	1	---	3	V
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=32V, V_{GS}=0V$	---	---	1	μA
I_{GSS}	Gate-Source Leakage Current	$V_{GS} = \pm 20V$	---	---	± 100	nA
g_{fs}	Forward Transconductance	$V_{DS}=5V, I_D=12A$	---	13	---	S
Q_g	Total Gate Charge	$V_{DD}=20V, I_D=7A$ $V_{GS}=0$ to 10V	---	14	---	nC
Q_{gs}	Gate-Source Charge		---	2	---	
Q_{gd}	Gate-Drain Charge		---	2.5	---	
$T_{d(on)}$	Turn-On Delay Time	$V_{DD}=20V, V_{GS}=10V, I_D=7A$ $R_{GEN}=6\Omega$	---	7	---	ns
T_r	Rise Time		---	3	---	
$T_{d(off)}$	Turn-Off Delay Time		---	20	---	
T_f	Fall Time		---	2	---	
C_{iss}	Input Capacitance	$V_{DS}=25V, V_{GS}=0V, f=1\text{MHz}$	---	850	---	pF
C_{oss}	Output Capacitance		---	90	---	
C_{rss}	Reverse Transfer Capacitance		---	50	---	

Diode Characteristics

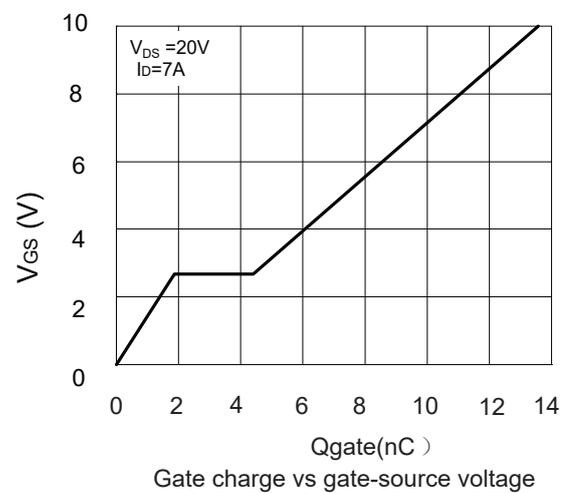
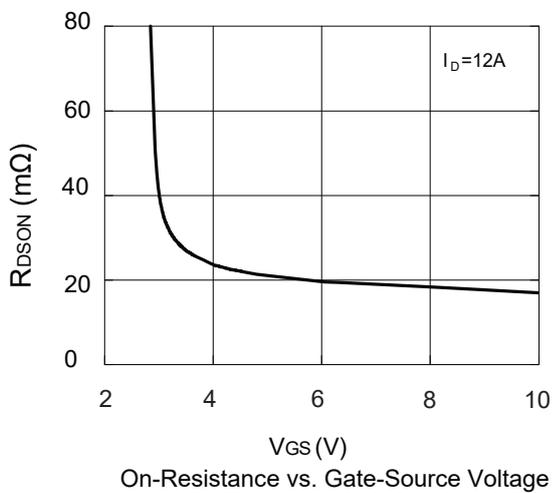
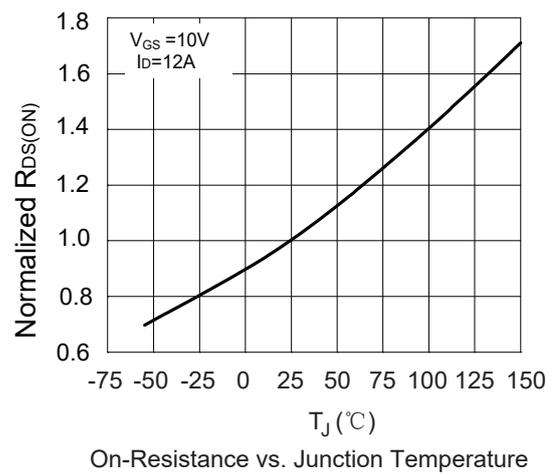
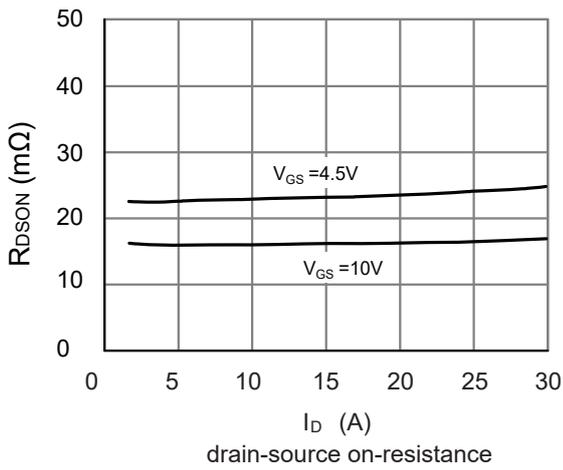
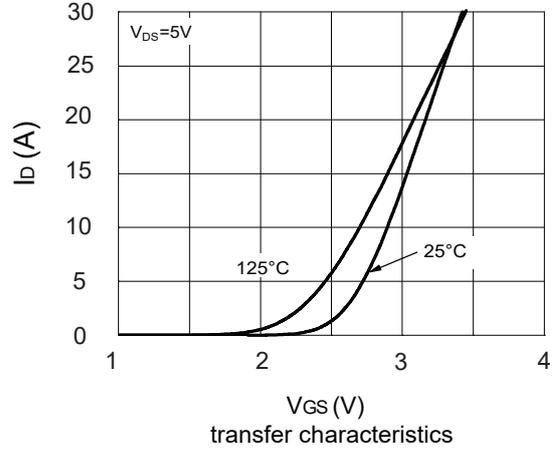
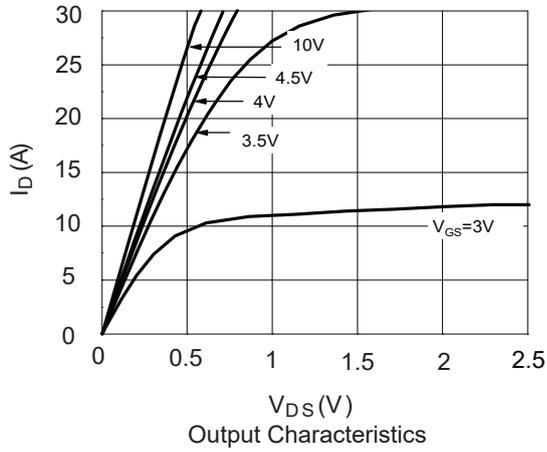
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_S	Diode continuous forward current	$V_G=V_D=0V$, Force Current	---	---	22	A
$I_{S,pulse}$	Diode pulse current		---	---	44	A
V_{SD}	Diode Forward Voltage	$V_{GS}=0V, I_F=12A, T_J=25^{\circ}\text{C}$	---	0.86	1.2	V

Notes:

1.The EAS data shows Max. rating .The test condition is $V_{DS}=20V, V_{GS}=10V, L=1\text{mH}, I_{AS}=11.6A$.

This product has been designed and qualified for the consumer market.
Cmos assumes no liability for customers' product design or applications.
Cmos reserves the right to improve product design ,functions and reliability without notice.

Typical Characteristics



Typical Characteristics

